Special Issue

Seismic Metamaterials

Message from the Guest Editors

Seismic metamaterials is an emerging topic at the interface between three communities: researchers working on the control of electromagnetic, acoustic, and elastodynamic waves, geophysicists, and civil engineers. This Special Issue aims at bridging these three disciplines together to provide a survey of recent progress on the control of seismic waves in structured soils.

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Deadline for manuscript submissions

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multidimensional network.

Editor-in-Chief

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